

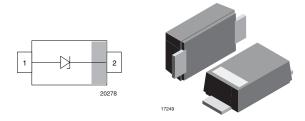
AUTOMOTIVE GRADE

RoHS

COMPLIANT

HALOGEN FREE

Surface Mount ESD Protection Diodes



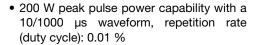
MARKING (example only)

Bar = cathode marking

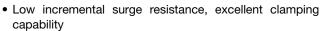
YY = type code (see table below)

XX = date code

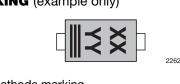
FEATURES



- Low-profile package
- Wave and reflow solderable
- ESD-protection acc. IEC 61000-4-2
 ± 30 kV contact discharge
 ± 30 kV air discharge
- ESD capability according to AEC-Q101: human body model: class H3B: > 8 kV



- · "Low-Noise" technology very fast response time
- AEC-Q101 qualified available
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ORDERING INFORMATION									
PART NUMBER (EXAMPLE)	ENV	/IRONMENTAL A	ND QUALITY COD	E	PACKAG	ORDERING CODE (EXAMPLE)			
	AEC-Q101 QUALIFIED	RoHS-COMPLIANT + LEAD (Pb)-FREE TERMINATIONS		TIN	3K PER 7" REEL (8 mm TAPE),			10K PER 13" REEL (8 mm TAPE),	
(,		STANDARD	HALOGEN-FREE	PLATED	30K/BOX = MOQ	50K/BOX = MOQ			
SMF5V0A-		E		3	-08		SMF5V0A-E3-08		
SMF5V0A-			М	3	-08		SMF5V0A-M3-08		
SMF5V0A-	Н	E		3	-08		SMF5V0A-HE3-08		
SMF5V0A-	Н		М	3	-08		SMF5V0A-HM3-08		
SMF5V0A-		Е		3		-18	SMF5V0A-E3-18		
SMF5V0A-			М	3		-18	SMF5V0A-M3-18		
SMF5V0A-	Н	E		3		-18	SMF5V0A-HE3-18		
SMF5V0A-	Н		М	3		-18	SMF5V0A-HM3-18		

PACKAGE DATA										
PACKAGE MOLDING COMPOUND		WEIGHT (mg)	HEIGHT MAX. (mm)	LENGTH MAX. (mm)	WIDTH MAX. (mm)	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	WHISKER TEST ACC. JESD 201	SOLDERING CONDITIONS	
SMF	Standard	15	1.08	3.9	1.9	UL 94 V-0	MSL level 1	class 2	Peak temperature max. 260 °C	
(DO-219AB)	Halogen-free	15				OL 94 V-0	(acc. J-STD-020)			



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT					
Peak pulse current	t _p = 10/1000 μs waveform	I _{PPM}	see "Electrical Characteristics"	А					
Peak pulse power	t _p = 8/20 μs waveform acc. IEC 61000-4-5	P _{PP}	1000	W					
Feak puise power	t _p = 10/1000 μs waveform	ГРР	200	W					
Peak forward surge current	8.3 ms single half sine-wave	I _{FSM}	50	Α					
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV					
ESD infiniting	Air discharge acc. IEC 61000-4-2; 10 pulses	V_{ESD}	± 30	kV					
Thermal resistance	Mounted on epoxy glass PCB with 3 mm x 3 mm, Cu pads (≥ 40 µm thick)	R _{thJA}	180	K/W					
Forward clamping voltage	$I_F = 50A$, $t_p = 400 \mu s$	V_{F}	2.5	V					
Junction temperature		T _J	175	°C					
Storage temperature range		T _{stg}	-65 to +175	°C					
Operating temperature range		T _{op}	-65 to +175	°C					

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)										
PART NUMBER	TYPE CODE		REVERSE BREAKDOWN VOLTAGE at I _T , t _p = 5 ms	TEST CURRENT	REVERSE WORKING VOLTAGE	REVERSE CURRENT at V _{RWM}	PEAK PULSE CURRENT t _p = 10/1000 μs	REVERSE CLAMPING VOLTAGE at I _{PPM}	CAPACITANCE at V _R = 0 V, f = 1 MHz	PROTECTION PATHS
	STD.	HALOGEN- FREE	V _{BR} MIN. (V)	I _T (mA)	V _{RWM} (V)	Ι _R (μΑ)	I _{PPM} (A)	V _C MAX. (V)	C _D TYP. (pF)	N _{channel}
SMF5V0A	AE	NE	6.40	10	5	5	21.7	9.2	1120	1
SMF6V0A	AG	NG	6.67	10	6	26	19.4	10.3	1063	1
SMF6V5A	AK	NK	7.22	10	6.5	20	17.9	11.2	938	1
SMF7V0A	AM	NM	7.78	10	7	3	16.7	12	843	1
SMF7V5A	AP	NP	8.33	1	7.5	0.1	15.5	12.9	773	1
SMF8V0A	AR	NR	8.89	1	8	0.1	14.7	13.6	706	1
SMF8V5A	AT	NT	9.44	1	8.5	0.1	13.9	14.4	674	1
SMF9V0A	AV	NV	10	1	9	0.1	13.5	15.4	640	1
SMF10A	AX	NX	11.1	1	10	0.1	11.8	17	562	1
SMF11A	ΑZ	NZ	12.2	1	11	0.1	11	18.2	509	1
SMF12A	BE	OE	13.3	1	12	0.1	10.1	19.9	483	1
SMF13A	BG	OG	14.4	1	13	0.1	9.3	21.5	423	1
SMF14A	BK	OK	15.6	1	14	0.1	8.6	23.2	392	1
SMF15A	ВМ	OM	16.7	1	15	0.1	8.2	24.4	367	1
SMF16A	BP	OP	17.8	1	16	0.1	7.7	26	343	1
SMF17A	BR	OR	18.9	1	17	0.1	7.2	27.6	324	1
SMF18A	BT	OT	20	1	18	0.1	6.8	29.2	320	1
SMF20A	BV	OV	22.2	1	20	0.1	6.2	32.4	283	1
SMF22A	BX	OX	24.4	1	22	0.1	5.6	35.5	271	1
SMF24A	BZ	OZ	26.7	1	24	0.1	5.1	38.9	244	1
SMF26A	CE	PE	28.9	1	26	0.1	4.8	42.1	230	1
SMF28A	CG	PG	31.1	1	28	0.1	4.4	45.4	227	1
SMF30A	CK	PK	33.3	1	30	0.1	4.1	48.4	207	1
SMF33A	CM	PM	36.7	1	33	0.1	3.8	53.3	198	1
SMF36A	СР	PP	40	1	36	0.1	3.4	58.1	178	1
SMF40A	CR	PR	44.4	1	40	0.1	3.1	64.5	172	1
SMF43A	CT	PT	47.8	1	43	0.1	2.9	69.4	165	1
SMF45A	CV	PV	50	1	45	0.1	2.8	72.7	162	1
SMF48A	CX	PX	53.3	1	48	0.1	2.6	77.4	161	1
SMF51A	CZ	PZ	56.7	1	51	0.1	2.4	82.4	151	1
SMF54A	CA	PA	60	1	54	0.1	2.25	88	148	1
SMF58A	CC	PC	64.4	1	58	0.1	2.1	95	144	1

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TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

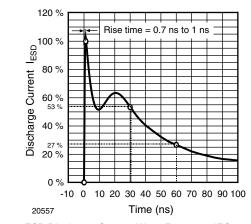


Fig. 1 - ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 $\Omega/150 pF$)

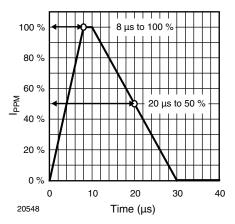


Fig. 2 - $8/20 \mu s$ Peak Pulse Current Wave Form acc. IEC 61000-4-5

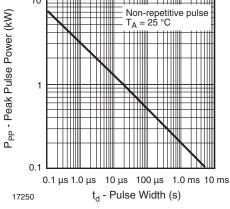


Fig. 3 - Peak Pulse Power Rating

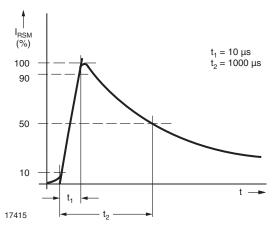


Fig. 4 - Pulse Waveform

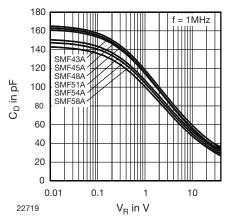


Fig. 5 - Typical Capacitance C_D vs. Reverse Voltage V_R

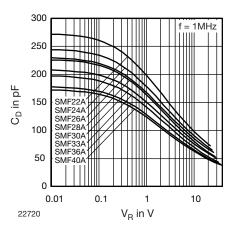


Fig. 6 - Typical Capacitance $C_D \, vs.$ Reverse Voltage V_R

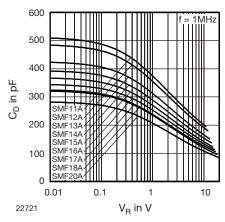


Fig. 7 - Typical Capacitance C_D vs. Reverse Voltage V_R

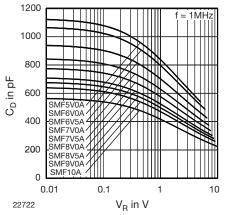


Fig. 8 - Typical Capacitance C_D vs. Reverse Voltage V_R

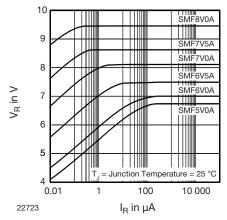


Fig. 9 - Typical Reverse Voltage V_{R} vs. Reverse Current I_{R}

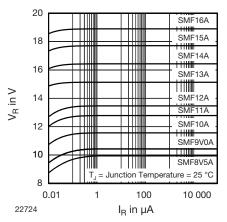


Fig. 10 - Typical Reverse Voltage V_R vs. Reverse Current I_R

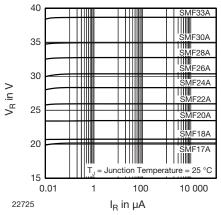


Fig. 11 - Typical Reverse Voltage V_R vs. Reverse Current I_R

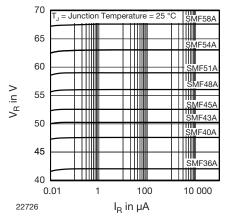
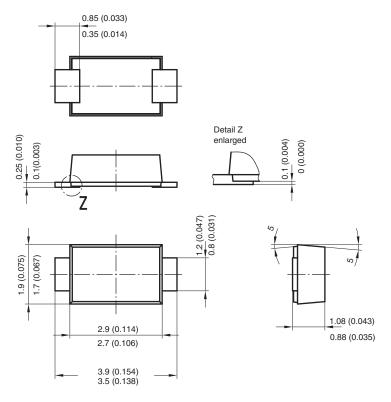
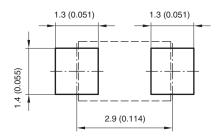


Fig. 12 - Typical Reverse Voltage V_{R} vs. Reverse Current I_{R}

PACKAGE DIMENSIONS in millimeters (inches): SMF

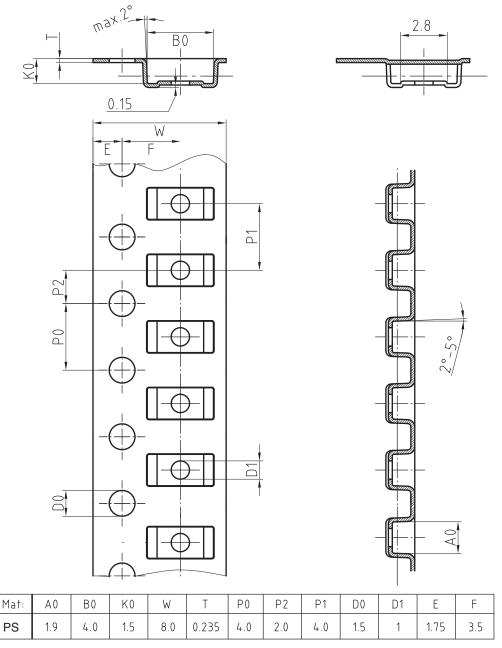


Foot print recommendation:



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BLISTERTAPE DIMENSIONS in millimeters (inches)

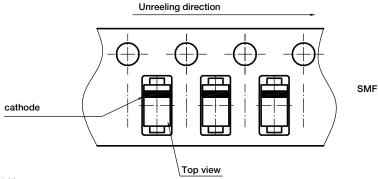


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ORIENTATION IN CARRIER TAPE - SMF



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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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